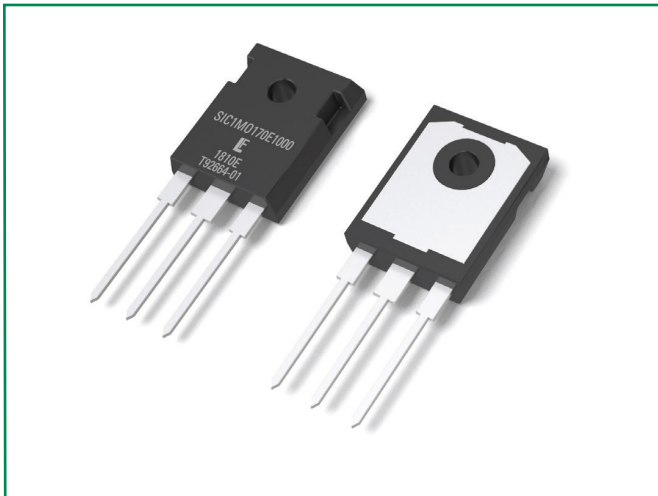


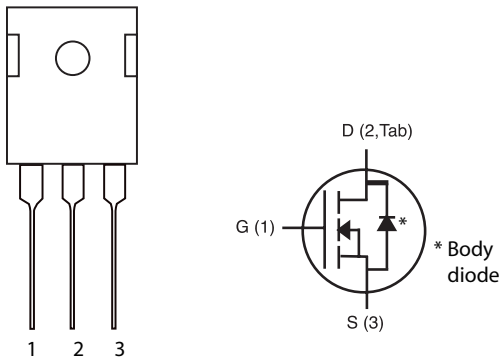
LSIC1MO170E1000 1700 V N-channel, Enhancement-mode SiC MOSFET **HF** **RoHS** **Pb**



Product Summary

Characteristics	Value	Unit
V_{DS}	1700	V
Typical $R_{DS(ON)}$	750	mΩ
I_D ($T_c \leq 100\text{ }^{\circ}\text{C}$)	3.5	A

Circuit Diagram TO-247-3L



Features

- Optimized for high-frequency, high-efficiency applications
- Extremely low gate charge and output capacitance
- Low gate resistance for high-frequency switching
- Normally-off operation at all temperatures
- Ultra-low on-resistance

Environmental

- Littelfuse "RoHS" logo = **RoHS**
RoHS conform
- Littelfuse "HF" logo = **HF**
Halogen Free
- Littelfuse "Pb-free" logo = **Pb**
Pb-free lead plating

Applications

- High-frequency applications
- Solar Inverters
- Switch Mode Power Supplies
- UPS
- Motor Drives
- High Voltage DC/DC Converters
- Battery Chargers
- Induction Heating

Maximum Ratings

Characteristics	Symbol	Conditions	Value	Unit
Continuous Drain Current	I_D	$V_{GS} = 20\text{ V}, T_C = 25\text{ }^\circ\text{C}$	5.0	A
		$V_{GS} = 20\text{ V}, T_C = 100\text{ }^\circ\text{C}$	3.5	
Pulsed Drain Current ¹	$I_{D(pulse)}$	$T_C = 25\text{ }^\circ\text{C}$	15	A
Power Dissipation	P_D	$T_C = 25\text{ }^\circ\text{C}, T_J = 150\text{ }^\circ\text{C}$	54	W
Operating Junction Temperature	T_J		-55 to 150	$^\circ\text{C}$
Gate-source Voltage	$V_{GS,MAX}$	Absolute maximum values	-6 to 22	V
	$V_{GS,OPTR}$	Transient, <1% duty cycle	-10 to 25	
	$V_{GS,OP}$	Recommended DC operating values	-5 to 20	
Storage Temperature	T_{STG}	-	-55 to 150	$^\circ\text{C}$
Lead Temperature for Soldering	T_{solder}	-	260	$^\circ\text{C}$
Mounting Torque	M_D	M3 or 6-32 screw	0.6	Nm
			5.3	in-lb

Footnote 1: Pulse width limited by $T_{J,max}$

Thermal Characteristics

Characteristics	Symbol	max	Unit
Maximum Thermal Resistance, junction-to-case	$R_{\theta JC}$	2.3	$^\circ\text{C/W}$
Maximum Thermal Resistance, junction-to-ambient	$R_{\theta JA}$	40	$^\circ\text{C/W}$

Electrical Characteristics ($T_J = 25\text{ }^\circ\text{C}$ unless otherwise specified)

Characteristics	Symbol	Conditions	Min	Typ	Max	Unit
Static Characteristics						
Drain-source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0\text{ V}, I_D = 250\text{ }\mu\text{A}$	1700	-	-	V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 1700\text{ V}, V_{GS} = 0\text{ V}$	-	0.05	10	μA
		$V_{DS} = 1700\text{ V}, V_{GS} = 0\text{ V}, T_J = 150\text{ }^\circ\text{C}$	-	0.10	-	
Gate Leakage Current	$I_{GSS,F}$	$V_{GS} = 22\text{ V}, V_{DS} = 0\text{ V}$	-	-	100	nA
	$I_{GSS,R}$	$V_{GS} = -6\text{ V}, V_{DS} = 0\text{ V}$	-	-	100	
Drain-source On-state Resistance	$R_{DS(ON)}$	$I_D = 2\text{ A}, V_{GS} = 20\text{ V}$	-	750	1000	m Ω
		$I_D = 2\text{ A}, V_{GS} = 15\text{ V}$	-	1000	-	
		$I_D = 2\text{ A}, V_{GS} = 20\text{ V}, T_J = 150\text{ }^\circ\text{C}$	-	1450	-	
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 1\text{ mA}$	1.8	2.5	4.0	V
		$V_{DS} = V_{GS}, I_D = 1\text{ mA}, T_J = 150\text{ }^\circ\text{C}$	-	1.6	-	
Gate Resistance	R_G	Resonance method, Drain-Source shorted	-	5.8	-	Ω

Electrical Characteristics ($T_J = 25\text{ }^{\circ}\text{C}$ unless otherwise specified)

Characteristics	Symbol	Conditions	Value			Unit
			Min	Typ	Max	
Dynamic Characteristics						
Turn-on Switching Energy	E _{ON}	V _{DD} = 1200 V, I _D = 2 A, V _{GS} = -5/+20 V, R _{G,ext} = 20 Ω, L = 1.4mH	-	59	-	μJ
Turn-off Switching Energy	E _{OFF}		-	25	-	
Total Per-cycle Switching Energy	E _{TS}		-	84	-	
Input Capacitance	C _{ISS}	V _{DD} = 1000 V, V _{GS} = 0 V, f = 1 MHz, V _{AC} = 25 mV	-	200	-	pF
Output Capacitance	C _{OSS}		-	11	-	
Reverse Transfer Capacitance	C _{RSS}		-	2	-	
C _{OSS} Stored Energy	E _{OSS}		-	5.3	-	μJ
Total Gate Charge	Q _g	V _{DD} = 1200 V, I _D = 2 A, V _{GS} = -5/+20 V	-	15	-	nC
Gate-source Charge	Q _{gs}		-	3	-	
Gate-drain Charge	Q _{gd}		-	7	-	
Turn-on Delay Time	t _{d(on)}	V _{DD} = 1200 V, V _{GS} = -5/+20 V, I _D = 2 A, R _{G,ext} = 20 Ω, R _L = 600 Ω, Timing relative to V _{DS}	-	9	-	ns
Rise Time	t _r		-	15	-	
Turn-off Delay Time	t _{d(off)}		-	17	-	
Fall Time	t _f		-	50	-	

Reverse Diode Characteristics

Characteristics	Symbol	Conditions	Value			Unit
			Min	Typ	Max	
Diode Forward Voltage	V_{SD}	$I_S = 1\text{ A}, V_{GS} = 0\text{ V}$	-	3.7	-	V
		$I_S = 1\text{ A}, V_{GS} = 0\text{ V}, T_J = 150\text{ }^{\circ}\text{C}$	-	3.4	-	
Continuous Diode Forward Current	I_S	$V_{GS} = 0\text{ V}, T_C = 25\text{ }^{\circ}\text{C}$	-	-	8	A
Peak Diode Forward Current ¹	I_{SP}		-	-	15	

Footnote 1: Pulse width limited by $T_{J,max}$

Figure 1: Maximum Power Dissipation ($T_J = 150^\circ\text{C}$)

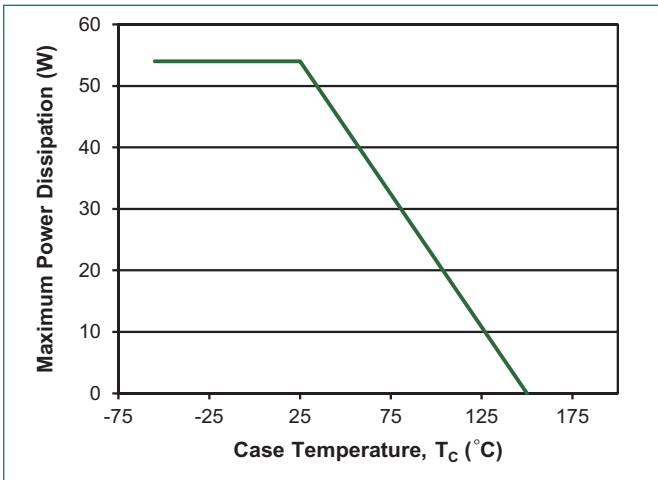


Figure 2: Transfer Characteristics ($V_{DS} = 10\text{ V}$)

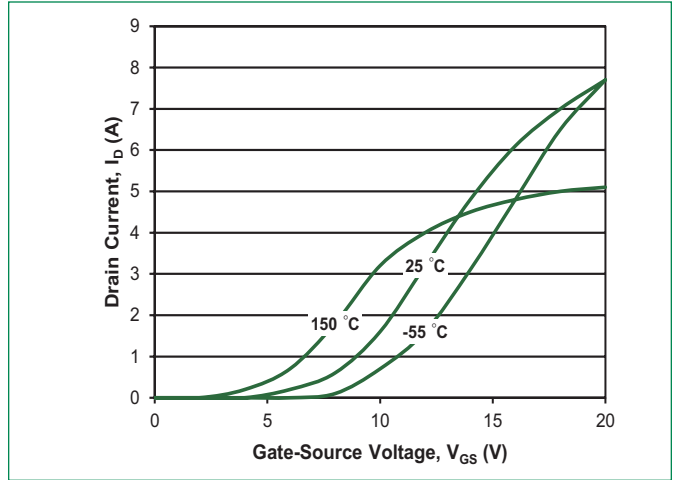


Figure 3: Output Characteristics ($T_J = 25^\circ\text{C}$)

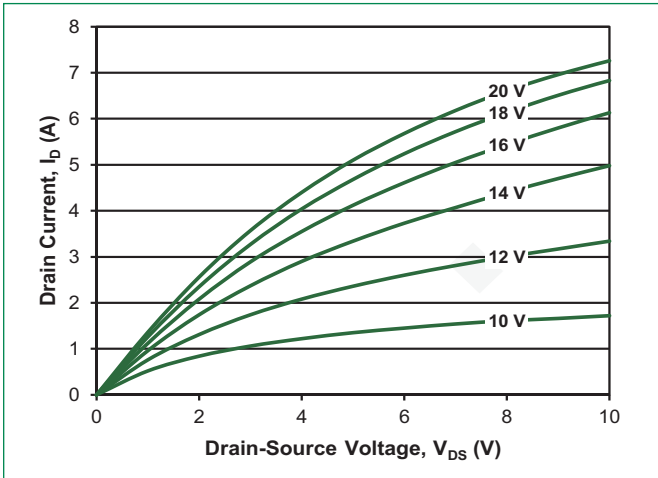


Figure 4: Output Characteristics ($T_J = 150^\circ\text{C}$)

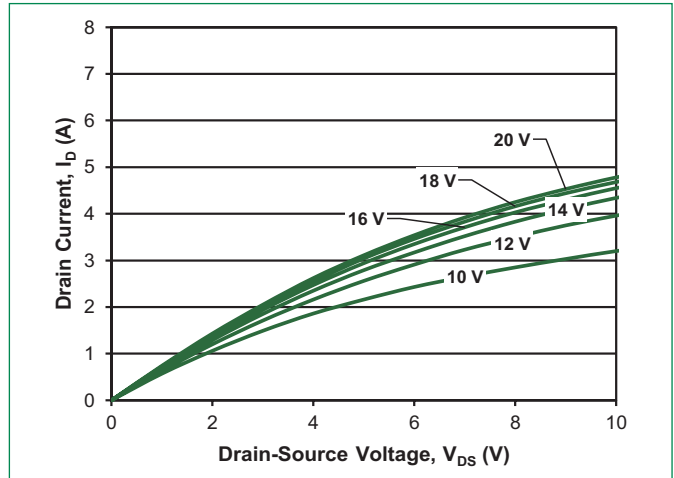


Figure 5: Output Characteristics ($T_J = -55^\circ\text{C}$)

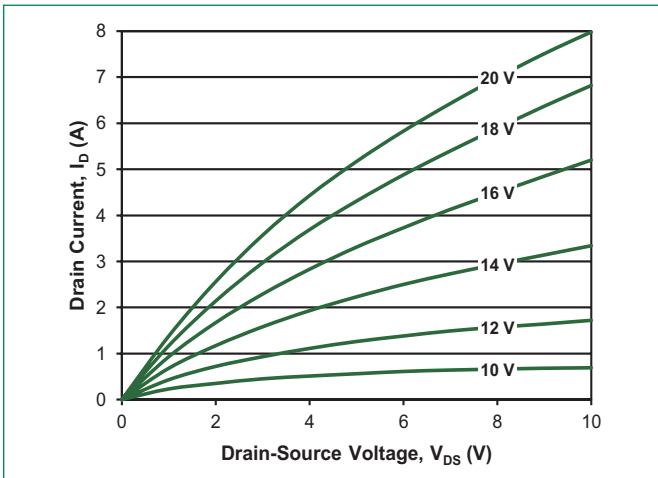


Figure 6: Reverse Conduction Characteristics ($T_J = 25^\circ\text{C}$)

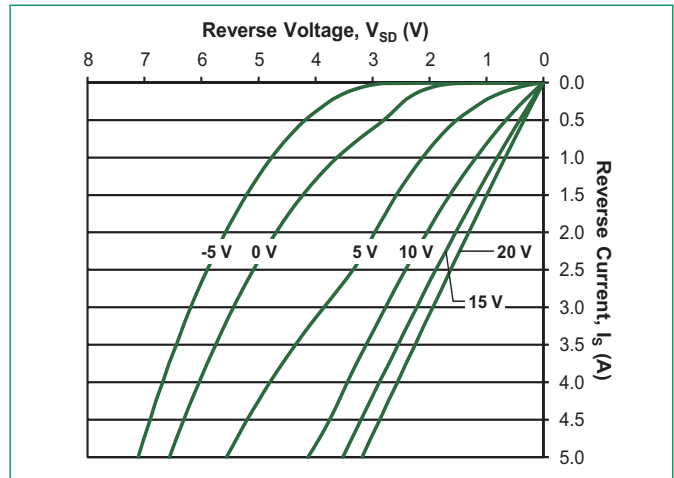


Figure 7: Reverse Conduction Characteristics ($T_J = 150^\circ\text{C}$)

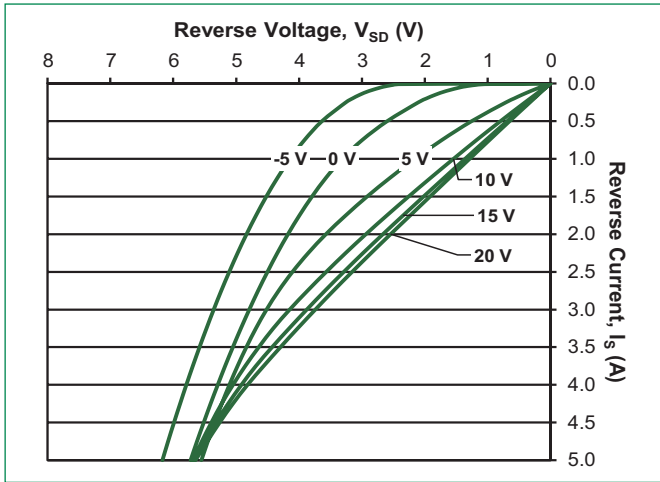


Figure 8: Reverse Conduction Characteristics ($T_J = -55^\circ\text{C}$)

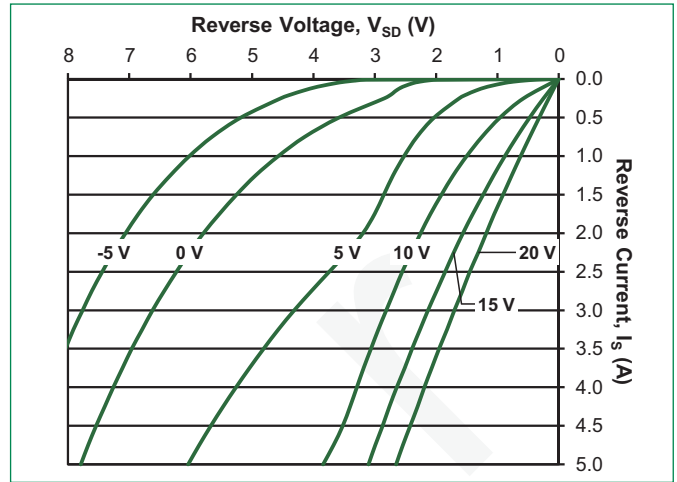


Figure 9: Transient Thermal Impedance

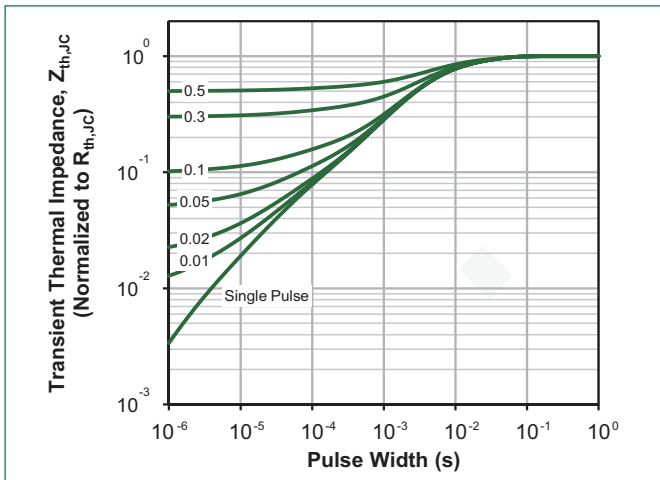


Figure 10: Safe Operating Area ($T_c = 25^\circ\text{C}$)

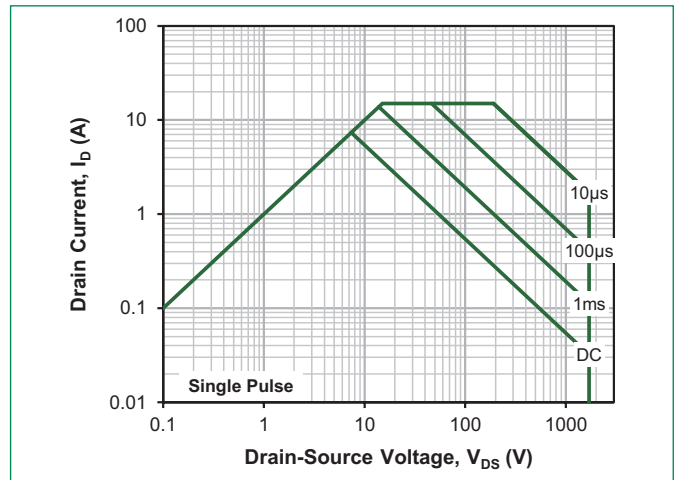


Figure 11: On-resistance vs. Drain Current

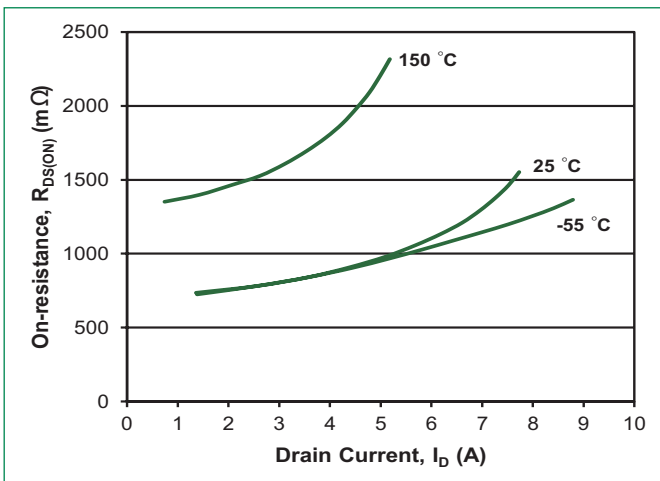


Figure 12: Normalized On-resistance

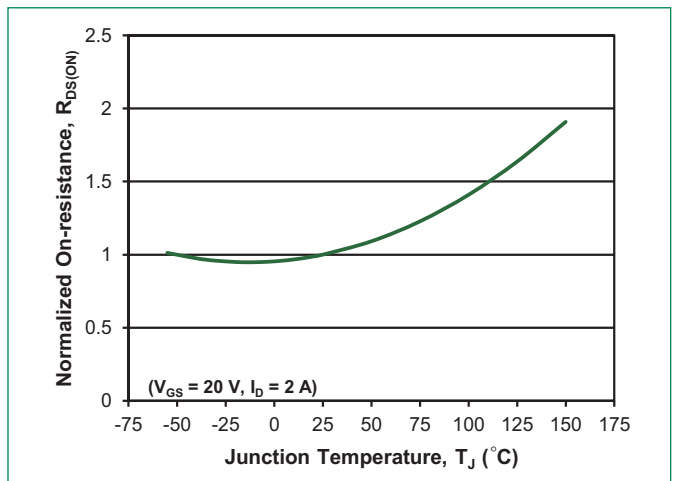


Figure 13: Threshold Voltage

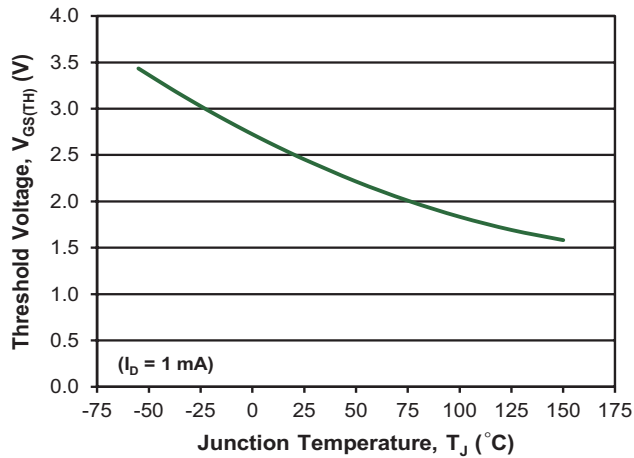


Figure 14: Drain-Source Blocking Voltage

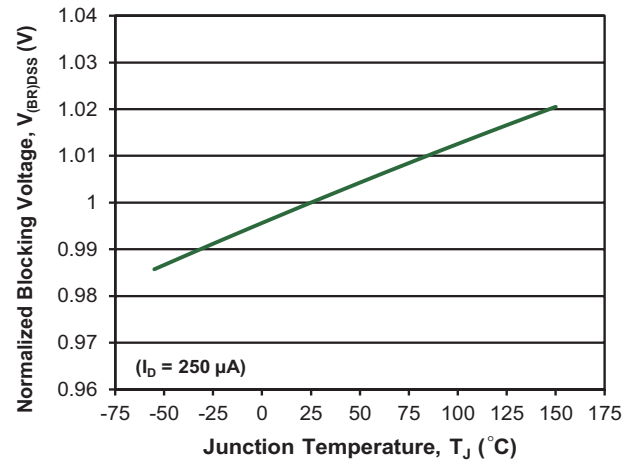


Figure 15: Junction Capacitances

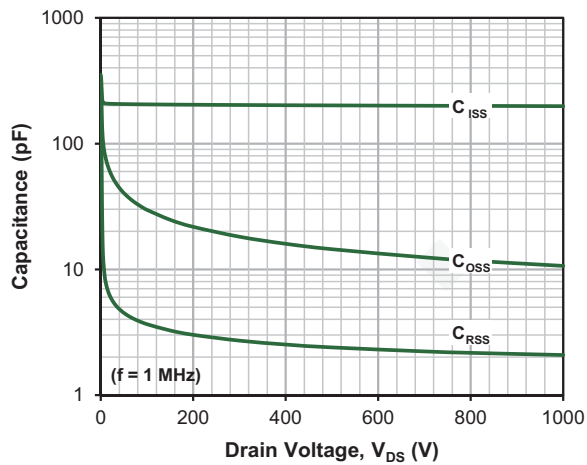


Figure 16: Junction Capacitances

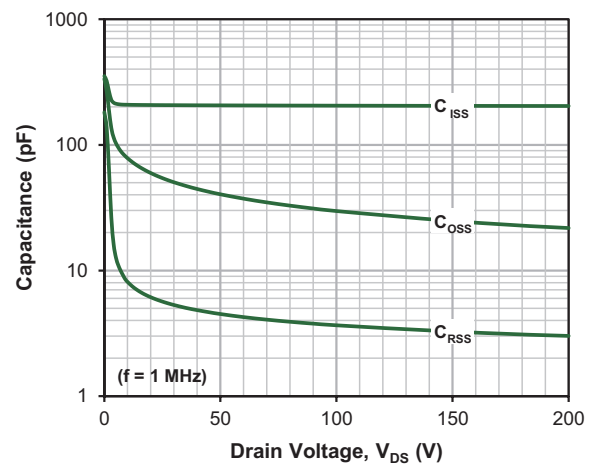


Figure 17: C_{OSS} Stored Energy E_{OSS}

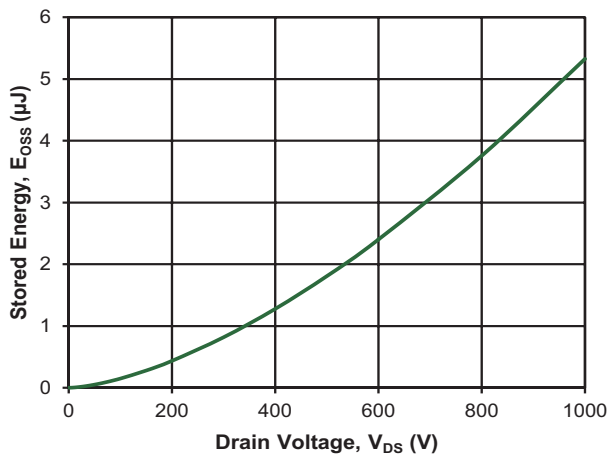


Figure 18: Gate Charge

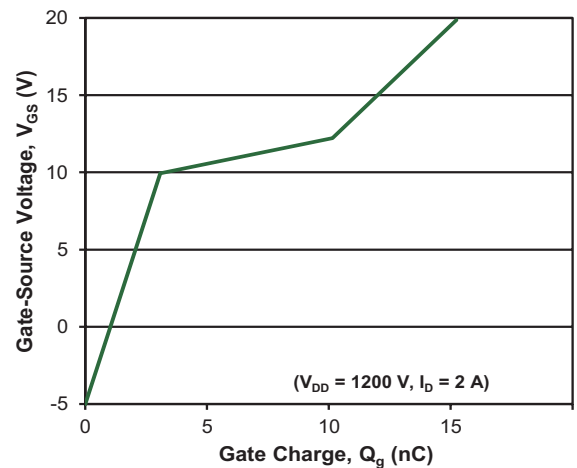


Figure 19: Switching Energy vs. Drain Current

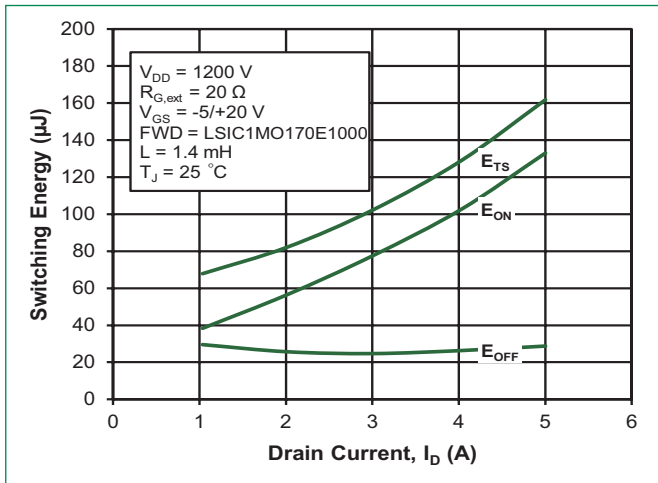
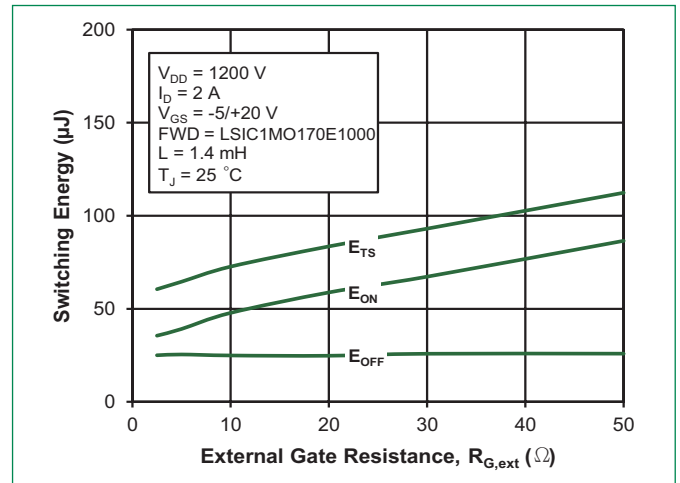
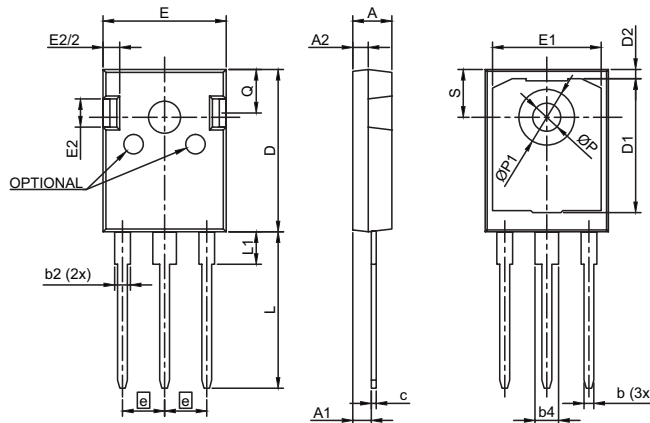


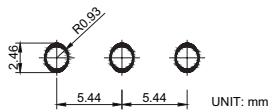
Figure 20: Switching Energy vs. Gate Resistance



Package Dimensions TO-247-3L



Recommended Hole Pattern Layout

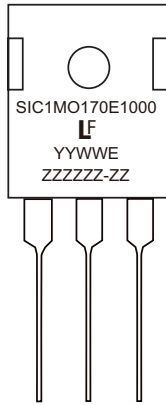


Notes:

1. Dimensions are in millimeters
2. Dimension D, E do not include mold flash. Mold flash shall not exceed 0.127 mm per side. These measured at the outermost extreme of plastic body.
3. ϕP to have a maximum draft angle of 1.5° to the top of the part with a maximum hole diameter of 0.154"

Symbol	Millimeters		
	Min	Nom	Max
A	4.80	5.03	5.20
A1	2.25	2.38	2.54
A2	1.85	1.98	2.11
b	0.99	-	1.40
b2	1.65	-	2.39
b4	2.59	-	3.43
c	0.38	0.64	0.89
D	20.80	20.96	21.34
D1	13.50	-	-
D2	0.51	1.19	1.35
e	5.44 BSC		
E	15.75	15.90	16.13
E1	13.06	14.02	14.15
E2	4.19	4.32	4.83
L	19.81	20.19	20.57
L1	3.81	4.19	4.45
ϕP	3.55	3.61	3.66
$\phi P1$	7.06	7.19	7.32
Q	5.49	5.61	6.20
S	6.05	6.17	6.30

Part Numbering and Marking System

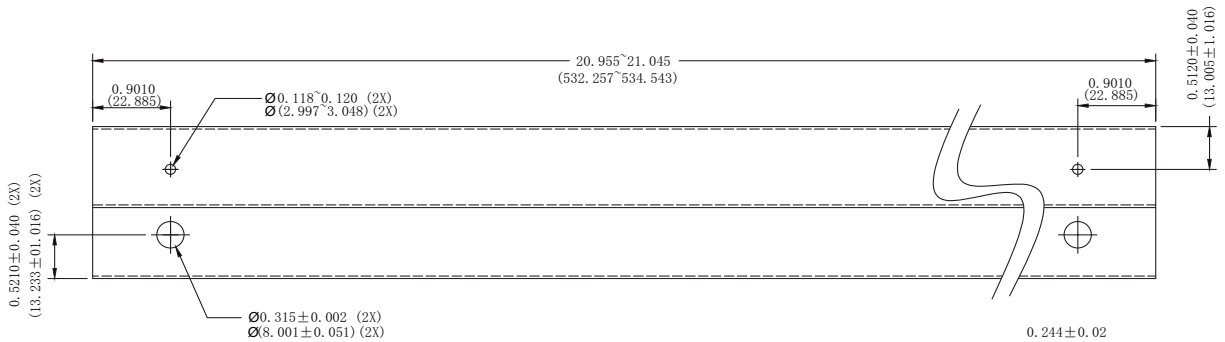


SiC = SiC
 1 = Gen1
 MO = MOSFET
 170 = Voltage Rating (1700 V)
 E = TO-247-3L
 1000 = $R_{DS(ON)}$ (1000 mOhm)
 YY = Year
 WW = Week
 E = Special Code
 ZZZZZZ-ZZ = Lot Number

Packing Options

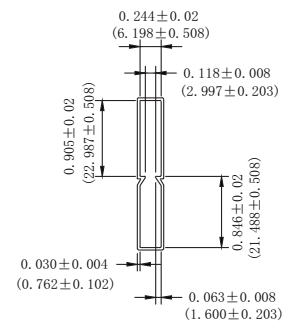
Part Number	Marking	Packing Mode	M.O.Q
LSIC1MO170E1000	SIC1MO170E1000	Tube (30pcs)	450

Packing Specification TO-247-3L



NOTE:

1. All pin plug holes are considered critical dimension
2. Tolerance is to be ± 0.010 unless otherwise specified
3. Dimension are in inches (and millimeters).



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